## 2.5-GHz Double Balanced Mixer

## **Description**

U2795B is a 2.5-GHz mixer for WLAN and RF telecommunications equipment, e.g., DECT and PCN, built with TELEFUNKEN's advanced bipolar technology. A double balanced approach was chosen to assure good

isolation characteristics and a minimum of spurious products. The input and output are single ended, and their characteristics are programmable. No output transformer or balun is required.

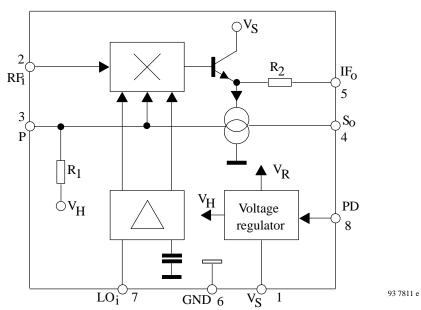
#### **Features**

- Supply voltage range: 2.7 to 5.5 V
- Single-ended output, no balun required
- Single-ended input for RF and LO
- Exellent isolation characteristics
- Power down mode
- IP3 and compression point programmable
- 2.5-GHz operating frequency
- SO-8 package

#### **Benefits**

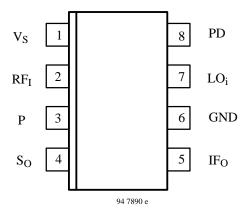
- Reduced system costs due to few external component (no balun) requirements
- Standard independent product
- 3-V operation reduces the battery count and saves space

## **Block Diagram**



## **U2795B**

### **Pin Description**



Pin	Symbol	Function
1	$V_{S}$	Supply voltage
2	RFi	RF input
3	P	Progamming port IP3, CP
4	$S_{O}$	Output symmetry
5	IFO	IF output
6	GND	Ground
7	LOi	LO input
8	PD	Power down

#### **Functional Description**

#### **Supply Voltage**

The IC is designed for a supply voltage of 2.7 to 5.5 V. As the IC is internally stabilized, the performance of the circuit is nearly independent of the supply voltage.

#### **Input Impedance**

Input impedance,  $Z_{RFi}$ , is about 700  $\Omega$  with an additional capacitive component. This condition provides the best noise figure in combination with a matching network.

#### 3. Order Intercept Point (IP3)

Voltage divider,  $R_P$  /  $R_{1}$ , determinates both the input and output intercept point, IIP3 and OIP3. If  $R_P$  is infinity the IIP3 has the maximum of about -4 dBm.

The IP3/R<sub>P</sub> characteristics are shown in figure 1 and 2.

#### **Output Impedance and Intercept Point**

Output impedance is shown in figure 9.

Both low output impedance and a high intercept point are with reference to a high value of R<sub>P</sub>.

#### Current Consumption, IS

Depending on the chosen input and output conditions of the IC, the current consumption,  $I_{S,}$  is between 4 mA and 10 mA. The current consumption in dependence of Rp is shown in figure 4.

#### **Power Down**

This feature provides an extension of battery life. If this function is not used, Pin 8 has to be connected to  $V_S$  (Pin 1).

#### **Output Symmetry**

The symmetry of the load current can be matched and so be optimized for a given load impedance.

## TELEFUNKEN Semiconductors

# **Absolute Maximum Ratings**

Parameters		Symbol	Value	Unit
Supply voltage	Pin 1	V <sub>S</sub>	6	V
Input voltage	Pins 2, 3, 7 and 8	$V_{\rm I}$	0 to V <sub>S</sub>	V
Junction temperature		T <sub>i</sub>	125	°C
Storage temperature range		T <sub>stg</sub>	-40  to  +125	°C

## **Thermal Resistance**

	Parameters	Symbol	Value	Unit
Junction ambient	SO 8	R <sub>thja</sub>	175	K/W

# **Operating Range**

Par	rameters	Symbol	Value	Unit
Supply voltage range	Pin 1	V <sub>S</sub>	2.7 to 5.5	V
Ambient temperature range		T <sub>amb</sub>	-40  to  +85	°C

# U2795B

### **Electrical Characteristics**

 $V_S=3~V,~f_{LOi}=1~GHz,~IF=900~MHz,~RF=100~MHz,~R_P=\infty~,~system~impedance~Zo=50~\Omega,~T_{amb}=25^{\circ}C,~R_T=56~\Omega~reference~point~Pin~6,~unless~otherwise~specified$ 

Parameters	Test Conditions / Pin	Symbol	Min.	Тур.	Max.	Unit
Supply voltage range	Pin 1	V <sub>S</sub>	2.7		5.5	V
Typical supply current range <sup>1</sup>	Pin 1	$I_S$	4		11	mA
Maximum supply current	Pin 1	$I_{\mathbf{S}}$			13	mA
Conversion power gain	$R_L = 50 \ \Omega, R_T = \infty$ $R_L = 50 \ \Omega, R_T = 56 \ \Omega$	PG <sub>C</sub> PG <sub>C</sub>		9 4		dB dB
Operating frequencies		-	•		•	
RF <sub>i</sub> frequency	Pin 2	RFi	10		2500	MHz
LO <sub>i</sub> frequency	Pin 7	$f_{LOi}$	50		2500	MHz
IF <sub>o</sub> frequency	Pin 5	f <sub>IFo</sub>	50		2500	MHz
Isolation					•	
LO spurious at RFi	Pin 7 to 2					
	$P_{iLO} = -10 \text{ to } 0 \text{ dBm}$	IS <sub>LO-RF</sub>		-30		dBm
RF <sub>i</sub> to LO <sub>i</sub>	Pin 2 to 7 $P_{iRF} = -25 \text{ dBm}$	IS <sub>RF-LO</sub>		35		dB
LO spurious at IF <sub>o</sub>	Pin 7 to 5, P <sub>iLO</sub> = -10 to 0 dBm	IS <sub>LO-IF</sub>		-25		dBm
IF <sub>o</sub> to LO <sub>i</sub>	Pin 5 to 7	IS <sub>IF-LO</sub>		30		dB
Output (IF)					•	
Output compression point	Pin 5	CPo		-10		dBm
Input (RF)	•				•	
Input impedance	Pin 2	Z <sub>RFi</sub>		700Ω  0.8pF		Ω
Input compression point	Pin 2	CPi		-14		dBm
Third order input	Pin 2	IIP3		-4		dBm
intercept point						
Input (LO)						
LO level	Pin 7	P <sub>iLO</sub>		-6		dBm
Voltage standing wave rat	io (VSWR)					
Input LO	Pin 7	VSWR <sub>LOi</sub>		<2		
Output IF	Pin 4	VSWR <sub>IFo</sub>		<2		
Noise performance	_					
Noise figure	$P_{iLO} = 0 \text{ dBm}, R_T = \infty$	NF		10		dB
Power down mode						
Supply current	$\begin{array}{cccc} Pin \ 1 & V_{PD} < 0.5 \ V \\ Pin \ 1 & V_{PD} = 0 \ V \end{array}$	$I_{SPD}$		<5	30	μΑ
Power down voltage						
"Power ON"	Pin 8 $V_S = 3.5 \text{ to } 5.5 \text{ V}$		V <sub>S</sub> -0.5		$V_{S} + 0.5$	V
	$V_S = 2.7 \text{ to } 3.5 \text{ V}$	V <sub>PON</sub>	$V_{S}$		$V_{S} + 0.5$	V
"Power DOWN"	Pin 8	V <sub>PDN</sub>			1	V
Power down current	Pin 8 Power ON	I <sub>PON</sub>		0.15		mA
	Power DOWN	I <sub>PDN</sub>		< 5		μΑ
Settling time	Pin 8 to 5	$t_{\mathrm{sPD}}$		<30		μs

Note 1: Depending on R<sub>P</sub>

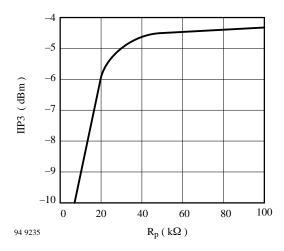


Figure 1. IIP3 versus resistor Rp, IF: 900 MHz

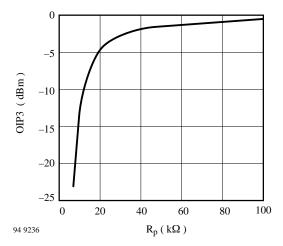


Figure 2. OIP3 versus resistor Rp, IF: 900 MHz

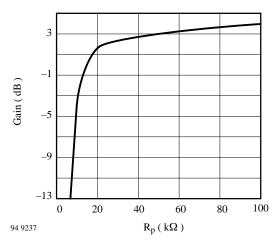


Figure 3. Gain versus resistor Rp, LO: 1030 MHz, level -10 dBm; RF: 130 MHz, -30 dBm, R<sub>T</sub>  $= 56 \Omega$ 

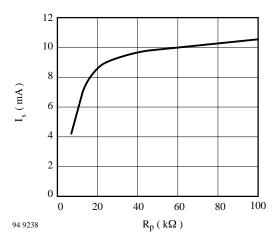


Figure 4. Supply current I<sub>S</sub> versus resistor Rp

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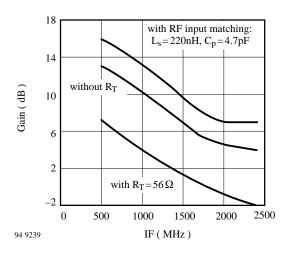


Figure 5. Gain versus IF output frequency, LO level: -6 dBm, RF: 130 MHz, -35 dBm; parameter: RF input termination

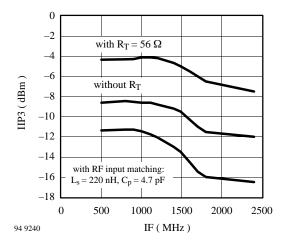


Figure 6. IIP3 versus IF output frequency, LO level: -6 dBm; RF: 130 MHz / 130.1 MHz, -35 dBm; parameter: RF input termination

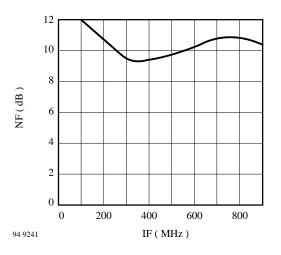


Figure 7. Double sideband noise figure versus IF output frequency; LO: 1000 MHz, level 0 dBm; no RF input matching,  $$\rm R_{\rm T}$$  left out

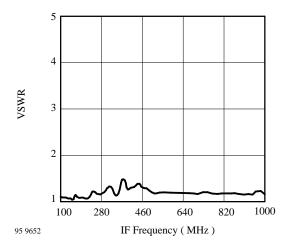
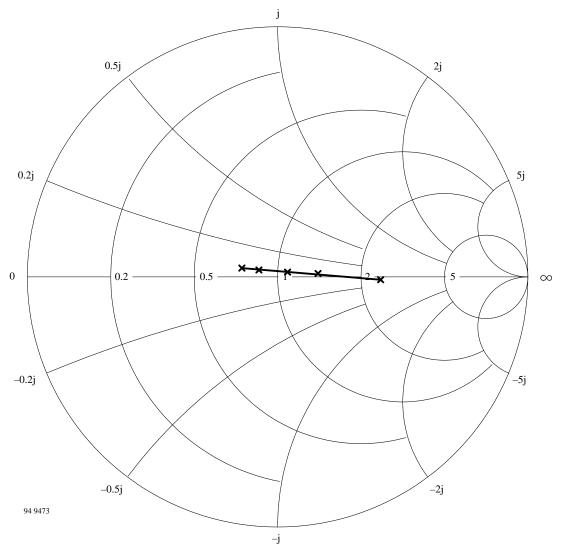


Figure 8. Typical VSWR frequency response of the IF output,  $R_P = \infty$ 



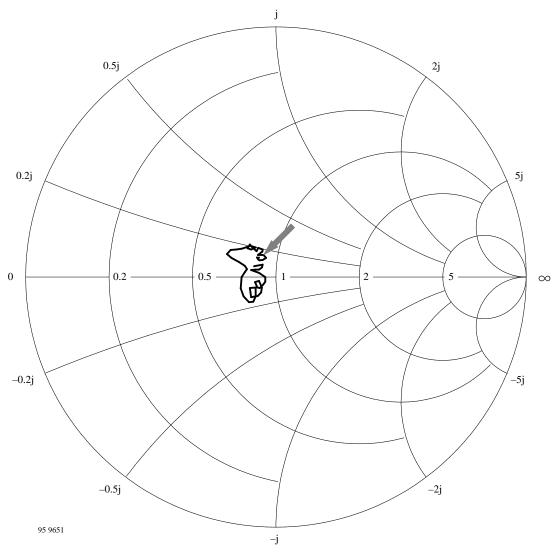


Figure 10. Typical S11 frequency response of the IF output,  $R_P\!=\!\infty$  , IF frequency from 100 MHz to 1000 MHz, marker: 900 MHz

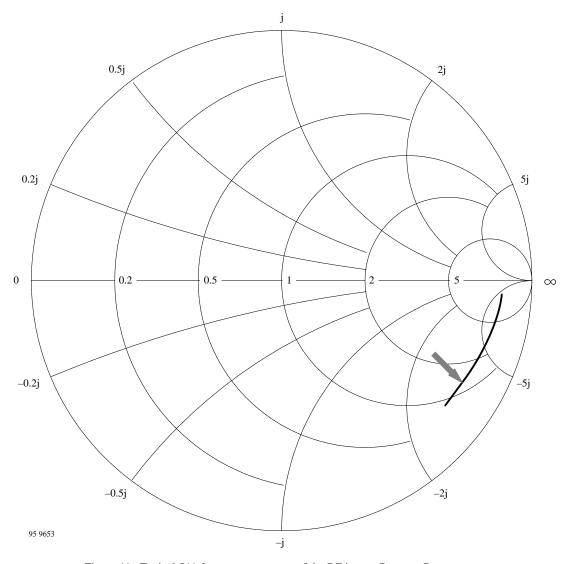


Figure 11. Typical S11 frequency response of the RF intput,  $R_P=\infty$  ,  $R_T=\infty$  RF frequency from 100 MHz to 1000 MHz, marker: 900 MHz

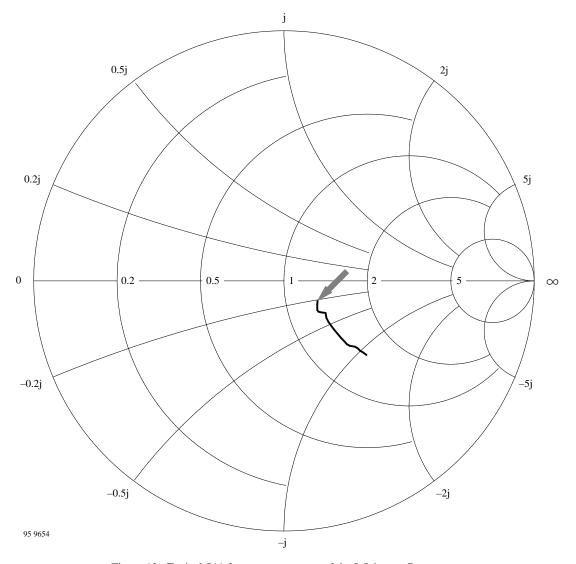
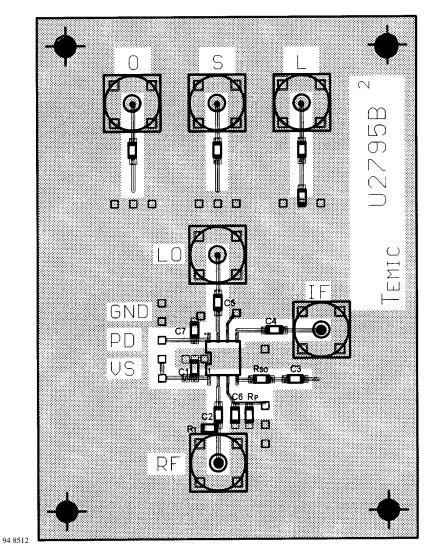
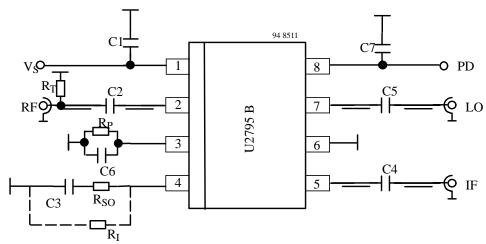


Figure 12. Typical S11 frequency response of the LO intput,  $R_P\!=\!\infty$  , LO frequency from 100 MHz to 1000 MHz, marker: 900 MHz

## **Application Circuit (Evaluation Board)**



# Application



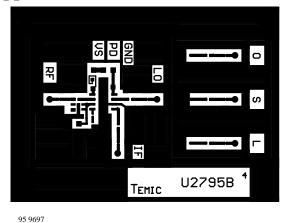
Part List				
C 1	10 nF			
C2, C3, C4, C5, C6, C7	100 pF			
*R <sub>P</sub>				
	50-Ω Microstrip			
*R <sub>SO</sub>	68 Ω			
	optional			
$R_{\mathrm{T}}$	56 Ω			

With the part list values, the PD settling time is  $<\!20~\mu s$ . Using other values, time requirements in burst-mode applications have to be considered.

Values of  $R_{SO}$  and  $R_P$  depending on the input and output condition requirements. For  $R_{SO}$  68  $\Omega$  is recommended.

With the optional  $R_I$  the intercept and compression point can be slightly increased; values between  $500\,\Omega$  and  $1\,k\Omega$  are suitable. Please note that such modification will also increase the supply current.

## **Application Board**

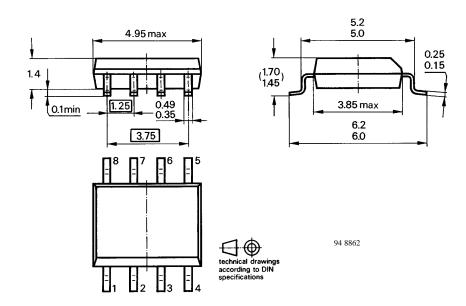


## **Ordering Information**

Extended Type Number	Package
U2795B-FP	SO 8

#### **Dimensions in mm**

Package: SO 8



### **Ozone Depleting Substances Policy Statement**

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**TEMIC TELEFUNKEN microelectronic GmbH** semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

**TEMIC** can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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